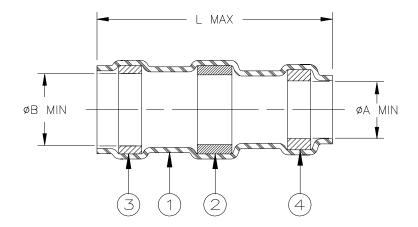
## **CUSTOMER DRAWING**



|              | Product Dimensions |         |         | Cable Dimensions |         |         |          |
|--------------|--------------------|---------|---------|------------------|---------|---------|----------|
| Product Name | L                  | Ø A     | Ø B     | Ø D              | ØΕ      | ØG      | J±0.5    |
|              | max                | min     | min     | max              | min     | max     | (J±0.02) |
| D-103-31     | 20.50              | 7.10    | 7.60    | 7.60             | 4.0     | 7.10    | 7.0      |
|              | (0.810)            | (0.280) | (0.300) | (0.300)          | (0.160) | (0.280) | (0.275)  |

## **MATERIALS**

- 1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
- 2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Sn63 per ANSI-J-STD-006.

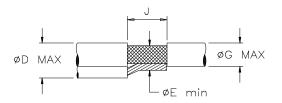
FLUX: TYPE ROM1 per ANSI-J-STD-004.

- 3. MELTABLE RING: Thermally stabilized thermoplastic. Color: blue.
- 4. MELTABLE RING: Thermally stabilized thermoplastic. Color: natural.

## **APPLICATION**

- 1. This part is designed to provide an environment protected shield termination on cables, rated for 125°C minimum, meeting the dimensional criteria listed, having nickel plated copper shields.
- 2. Install using TE Connectivity/Raychem-approved convection or infrared tools in accordance with Raychem assembly procedure RCPS-100-70.
- 3. Assemblies will meet requirements of Raychem specification RT-1404 and National Aerospace Standard NAS-1747.
- 4. Temperature range:  $-55^{\circ}$ C to  $+150^{\circ}$ C.

For best results, prepare the cable as shown:



Note:

Ground lead should be pre-tinned with Sn63 solder.

| =TE   |               | <i>Raychem</i><br>THERMOFIT<br>DEVICES |   | SOLDERSLEEVE* SHIELD TERMINATOR |            |                   |  |  |
|---|---------------|--|---|---------------------------------|------------|-------------------|--|--|
| Unless otherwise specified dimensions are in millimeters.  [Inches dimensions are shown in brackets]  TOLERANCES: ANGLES: N/A TE Connectivity reserves the right to |               |  |   |                                 | D-103-31   |                   |  |  |
| 0.00 N/A<br>0.0 N/A<br>0 N/A  | ROUG<br>MICRO | HNESS IN<br>ON                         | amend this drawing at any time. Users should evaluate the suitability of the product for their application. |                                 | REV:       | DATE: 17-APR-2020 |  |  |
| DRAWN BY: DATE:<br>M. FORONDA 22-MAR-   |               | -99                                    | ECO:<br>ECO-20-005247   | SCALE:<br>NTS                   | SIZE:<br>A | SHEET:<br>1 of 1  |  |  |

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